74AUP1G240

Low-power inverting buffer/line driver; 3-state

Rev. 5 — 15 March 2019 Product data sheet

1. General description

The 74AUP1G240 provides the single inverting buffer/line driver with 3-state output. The 3-state output is controlled by the output enable input ($\overline{OE}$). A HIGH level at pin $\overline{OE}$ causes the output to assume a high-impedance OFF-state.

This device has the input-disable feature, which allows floating input signals. The inputs are disabled when the output enable input $\overline{OE}$ is HIGH.

Schmitt-trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial Power-down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 5000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; I_{CC} = 0.9 μA (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- Input-disable feature allows floating input conditions
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

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3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AUP1G240GW	-40 °C to +125 °C	TSSOP5	plastic thin shrink small outline package; 5 leads; body width 1.25 mm	SOT353-1
74AUP1G240GM	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm	SOT886
74AUP1G240GF	-40 °C to +125 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm	SOT891
74AUP1G240GN	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm	SOT1115
74AUP1G240GS	-40 °C to +125 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm	SOT1202
74AUP1G240GX	-40 °C to +125 °C	X2SON5	X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 x 0.8 x 0.35 mm	SOT1226

4. Marking

Table 2. Marking

Type number	Marking code[1]
74AUP1G240GW	p2
74AUP1G240GM	p2
74AUP1G240GF	p2
74AUP1G240GN	p2
74AUP1G240GS	p2
74AUP1G240GX	p2

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram

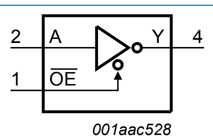


Fig. 1. Logic symbol

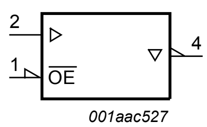


Fig. 2. IEC logic symbol

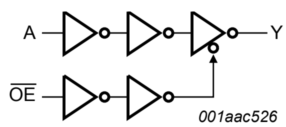


Fig. 3. Logic diagram

6. Pinning information

6.1. Pinning

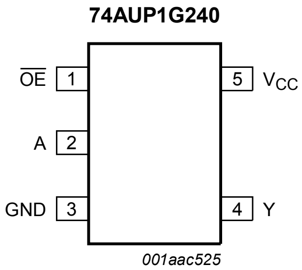


Fig. 4. Pin configuration SOT353-1 (TSSOP5)

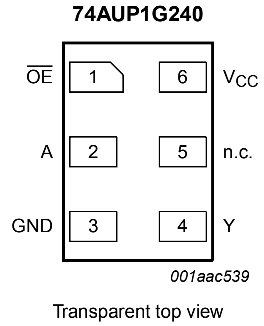


Fig. 5. Pin configuration SOT886 (XSON6)

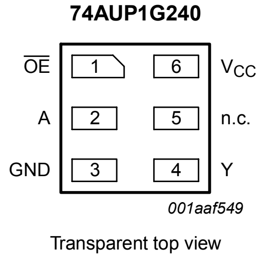


Fig. 6. Pin configuration SOT891, SOT1115 and SOT1202 (XSON6)

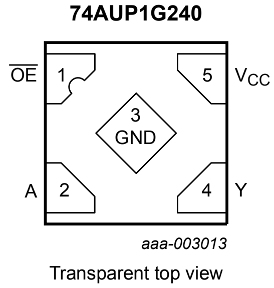


Fig. 7. Pin configuration SOT1226 (X2SON5)

6.2. Pin description

Table 3. Pin description

Symbol	Pin		Description
	TSSOP5 and X2SON5	XSON6	
$\overline{OE}$	1	1	output enable input
A	2	2	data input
GND	3	3	ground (0 V)
Y	4	4	data output
n.c.	-	5	not connected
V_{CC}	5	6	supply voltage

7. Functional description

Table 4. Function table

H = HIGH voltage level; L = LOW voltage level; X = Don't care; Z = high-impedance OFF-state.

Input		Output
$\overline{OE}$	A	Y
L	L	H
L	H	L
H	X	Z

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			-0.5	+4.6	V
I_{IK}	input clamping current	$V_I < 0$ V		-50	-	mA
V_I	input voltage		[1]	-0.5	+4.6	V
I_{OK}	output clamping current	$V_O < 0$ V		-50	-	mA
V_O	output voltage	Active mode and Power-down mode	[1]	-0.5	+4.6	V
I_O	output current	V_O = 0 V to V_{CC}		-	±20	mA
I_{CC}	supply current			-	50	mA
I_{GND}	ground current			-50	-	mA
T_{stg}	storage temperature			-65	+150	°C
P_{tot}	total power dissipation	T_{amb} = -40 °C to +125 °C	[2]	-	250	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For TSSOP5 packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K.
For XSON6 and X2SON5 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 6. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		0.8	3.6	V
V_I	input voltage		0	3.6	V
V_O	output voltage	Active mode	0	V_{CC}	V
		Power-down mode; V_{CC} = 0 V	0	3.6	V
T_{amb}	ambient temperature		-40	+125	°C
Δt/ΔV	input transition rise and fall rate	V_{CC} = 0.8 V to 3.6 V	0	200	ns/V

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = 25 °C						
V_{IH}	HIGH-level input voltage	V_{CC} = 0.8 V	0.70 × V_{CC}	-	-	V
		V_{CC} = 0.9 V to 1.95 V	0.65 × V_{CC}	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		V_{CC} = 3.0 V to 3.6 V	2.0	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 0.8 V	-	-	0.30 × V_{CC}	V
		V_{CC} = 0.9 V to 1.95 V	-	-	0.35 × V_{CC}	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V_{CC} = 3.0 V to 3.6 V	-	-	0.9	V

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		I_O = -20 μA; V_{CC} = 0.8 V to 3.6 V		V_{CC} - 0.1	-	-	V
		I_O = -1.1 mA; V_{CC} = 1.1 V		0.75 × V_{CC}	-	-	V
		I_O = -1.7 mA; V_{CC} = 1.4 V		1.11	-	-	V
		I_O = -1.9 mA; V_{CC} = 1.65 V		1.32	-	-	V
		I_O = -2.3 mA; V_{CC} = 2.3 V		2.05	-	-	V
		I_O = -3.1 mA; V_{CC} = 2.3 V		1.9	-	-	V
		I_O = -2.7 mA; V_{CC} = 3.0 V		2.72	-	-	V
		I_O = -4.0 mA; V_{CC} = 3.0 V		2.6	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		I_O = 20 μA; V_{CC} = 0.8 V to 3.6 V		-	-	0.1	V
		I_O = 1.1 mA; V_{CC} = 1.1 V		-	-	0.3 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V		-	-	0.31	V
		I_O = 1.9 mA; V_{CC} = 1.65 V		-	-	0.31	V
		I_O = 2.3 mA; V_{CC} = 2.3 V		-	-	0.31	V
		I_O = 3.1 mA; V_{CC} = 2.3 V		-	-	0.44	V
		I_O = 2.7 mA; V_{CC} = 3.0 V		-	-	0.31	V
		I_O = 4.0 mA; V_{CC} = 3.0 V		-	-	0.44	V
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V		-	-	±0.1	μA
I_{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL}; V_O = 0 V to 3.6 V; V_{CC} = 0 V to 3.6 V		-	-	±0.1	μA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V		-	-	±0.2	μA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V		-	-	±0.2	μA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V		-	-	0.5	μA
ΔI_{CC}	additional supply current	data input; $V_I = V_{CC}$ - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V	[1]	-	-	40	μA
		$\overline{OE}$ input; $V_I = V_{CC}$ - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V	[1]	-	-	110	μA
		all inputs; V_I = GND to 3.6 V; $\overline{OE} = V_{CC}$; V_{CC} = 0.8 V to 3.6 V	[2]	-	-	1	μA
C_I	input capacitance	V_{CC} = 0 V to 3.6 V; V_I = GND or V_{CC}		-	0.8	-	pF
C_O	output capacitance						
	output enabled	V_O = GND; V_{CC} = 0 V		-	1.7	-	pF
	output disabled	V_{CC} = 0 V to 3.6 V; V_O = GND or V_{CC}		-	1.5	-	pF

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = -40 °C to +85 °C						
V_{IH}	HIGH-level input voltage	V_{CC} = 0.8 V	0.70 × V_{CC}	-	-	V
		V_{CC} = 0.9 V to 1.95 V	0.65 × V_{CC}	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		V_{CC} = 3.0 V to 3.6 V	2.0	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 0.8 V	-	-	0.30 × V_{CC}	V
		V_{CC} = 0.9 V to 1.95 V	-	-	0.35 × V_{CC}	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V_{CC} = 3.0 V to 3.6 V	-	-	0.9	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL}				
		I_O = -20 μA; V_{CC} = 0.8 V to 3.6 V	V_{CC} - 0.1	-	-	V
		I_O = -1.1 mA; V_{CC} = 1.1 V	0.7 × V_{CC}	-	-	V
		I_O = -1.7 mA; V_{CC} = 1.4 V	1.03	-	-	V
		I_O = -1.9 mA; V_{CC} = 1.65 V	1.30	-	-	V
		I_O = -2.3 mA; V_{CC} = 2.3 V	1.97	-	-	V
		I_O = -3.1 mA; V_{CC} = 2.3 V	1.85	-	-	V
		I_O = -2.7 mA; V_{CC} = 3.0 V	2.67	-	-	V
		I_O = -4.0 mA; V_{CC} = 3.0 V	2.55	-	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}				
		I_O = 20 μA; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I_O = 1.1 mA; V_{CC} = 1.1 V	-	-	0.3 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V	-	-	0.37	V
		I_O = 1.9 mA; V_{CC} = 1.65 V	-	-	0.35	V
		I_O = 2.3 mA; V_{CC} = 2.3 V	-	-	0.33	V
		I_O = 3.1 mA; V_{CC} = 2.3 V	-	-	0.45	V
		I_O = 2.7 mA; V_{CC} = 3.0 V	-	-	0.33	V
		I_O = 4.0 mA; V_{CC} = 3.0 V	-	-	0.45	V
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V	-	-	±0.5	μA
I_{OZ}	OFF-state output current	V_I = V_{IH} or V_{IL}; V_O = 0 V to 3.6 V; V_{CC} = 0 V to 3.6 V	-	-	±0.5	μA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V	-	-	±0.5	μA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V	-	-	±0.6	μA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V	-	-	0.9	μA
ΔI_{CC}	additional supply current	data input; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V [1]	-	-	50	μA
		$\overline{OE}$ input; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V [1]	-	-	120	μA
		all inputs; V_I = GND to 3.6 V; $\overline{OE}$ = V_{CC}; V_{CC} = 0.8 V to 3.6 V [2]	-	-	1	μA

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
T_{amb} = -40 °C to +125 °C							
V_{IH}	HIGH-level input voltage	V_{CC} = 0.8 V		0.75 × V_{CC}	-	-	V
		V_{CC} = 0.9 V to 1.95 V		0.70 × V_{CC}	-	-	V
		V_{CC} = 2.3 V to 2.7 V		1.6	-	-	V
		V_{CC} = 3.0 V to 3.6 V		2.0	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 0.8 V		-	-	0.25 × V_{CC}	V
		V_{CC} = 0.9 V to 1.95 V		-	-	0.30 × V_{CC}	V
		V_{CC} = 2.3 V to 2.7 V		-	-	0.7	V
		V_{CC} = 3.0 V to 3.6 V		-	-	0.9	V
V_{OH}	HIGH-level output voltage	V_I = V_{IH} or V_{IL}					
		I_O = -20 μA; V_{CC} = 0.8 V to 3.6 V		V_{CC} - 0.11	-	-	V
		I_O = -1.1 mA; V_{CC} = 1.1 V		0.6 × V_{CC}	-	-	V
		I_O = -1.7 mA; V_{CC} = 1.4 V		0.93	-	-	V
		I_O = -1.9 mA; V_{CC} = 1.65 V		1.17	-	-	V
		I_O = -2.3 mA; V_{CC} = 2.3 V		1.77	-	-	V
		I_O = -3.1 mA; V_{CC} = 2.3 V		1.67	-	-	V
		I_O = -2.7 mA; V_{CC} = 3.0 V		2.40	-	-	V
		I_O = -4.0 mA; V_{CC} = 3.0 V		2.30	-	-	V
V_{OL}	LOW-level output voltage	V_I = V_{IH} or V_{IL}					
		I_O = 20 μA; V_{CC} = 0.8 V to 3.6 V		-	-	0.11	V
		I_O = 1.1 mA; V_{CC} = 1.1 V		-	-	0.33 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V		-	-	0.41	V
		I_O = 1.9 mA; V_{CC} = 1.65 V		-	-	0.39	V
		I_O = 2.3 mA; V_{CC} = 2.3 V		-	-	0.36	V
		I_O = 3.1 mA; V_{CC} = 2.3 V		-	-	0.50	V
		I_O = 2.7 mA; V_{CC} = 3.0 V		-	-	0.36	V
		I_O = 4.0 mA; V_{CC} = 3.0 V		-	-	0.50	V
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V		-	-	±0.75	μA
I_{OZ}	OFF-state output current	V_I = V_{IH} or V_{IL}; V_O = 0 V to 3.6 V; V_{CC} = 0 V to 3.6 V		-	-	±0.75	μA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V		-	-	±0.75	μA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V		-	-	±0.75	μA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V		-	-	1.4	μA
ΔI_{CC}	additional supply current	data input; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V	[1]	-	-	75	μA
		$\overline{OE}$ input; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 3.3 V	[1]	-	-	180	μA
		all inputs; V_I = GND to 3.6 V; $\overline{OE}$ = V_{CC}; V_{CC} = 0.8 V to 3.6 V	[2]	-	-	1	μA

[1] One input at V_{CC} - 0.6 V, other input at V_{CC} or GND.
[2] To show I_{CC} remains very low when the input-disable feature is enabled.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 10

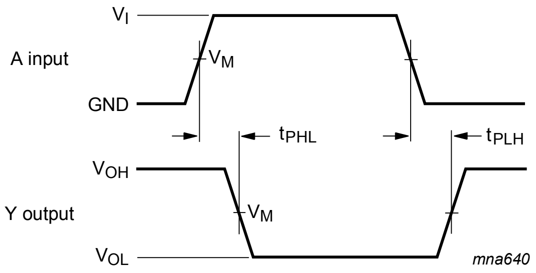
Symbol	Parameter	Conditions		25 °C			-40 °C to +125 °C			Unit
				Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C_L = 5 pF										
t_{pd}	propagation delay	A to Y; see Fig. 8	[2]							
		V_{CC} = 0.8 V		-	22.3	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		3.0	5.8	12.6	2.8	14.1	15.5	ns
		V_{CC} = 1.4 V to 1.6 V		2.3	4.0	7.3	2.1	8.5	9.5	ns
		V_{CC} = 1.65 V to 1.95 V		2.0	3.2	5.5	1.9	6.7	7.4	ns
		V_{CC} = 2.3 V to 2.7 V		1.8	2.6	4.1	1.5	4.8	5.3	ns
		V_{CC} = 3.0 V to 3.6 V		1.4	2.3	3.6	1.3	4.1	4.6	ns
t_{en}	enable time	$\overline{OE}$ to Y; see Fig. 9	[3]							
		V_{CC} = 0.8 V		-	70.2	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		3.1	6.4	14.3	2.8	15.9	17.5	ns
		V_{CC} = 1.4 V to 1.6 V		2.5	4.4	8.1	2.2	9.5	10.5	ns
		V_{CC} = 1.65 V to 1.95 V		2.1	3.6	6.2	1.9	7.4	8.2	ns
		V_{CC} = 2.3 V to 2.7 V		1.8	2.8	4.6	1.7	5.4	6.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.7	2.5	4.0	1.7	4.7	5.3	ns
t_{dis}	disable time	$\overline{OE}$ to Y; see Fig. 9	[4]							
		V_{CC} = 0.8 V		-	14.8	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		2.0	4.3	7.4	2.3	8.3	9.2	ns
		V_{CC} = 1.4 V to 1.6 V		1.6	3.2	5.2	1.7	5.9	6.5	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	3.0	4.8	1.5	5.5	6.1	ns
		V_{CC} = 2.3 V to 2.7 V		1.1	2.2	3.5	1.4	4.0	4.5	ns
		V_{CC} = 3.0 V to 3.6 V		1.3	2.5	3.9	1.4	4.5	5.0	ns
C_L = 10 pF										
t_{pd}	propagation delay	A to Y; see Fig. 8	[2]							
		V_{CC} = 0.8 V		-	25.7	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		3.5	6.6	14.5	3.2	16.3	18.0	ns
		V_{CC} = 1.4 V to 1.6 V		2.2	4.6	8.4	2.0	9.9	10.9	ns
		V_{CC} = 1.65 V to 1.95 V		2.0	3.8	6.4	1.8	7.7	8.6	ns
		V_{CC} = 2.3 V to 2.7 V		1.8	3.1	4.8	1.7	5.7	6.4	ns
		V_{CC} = 3.0 V to 3.6 V		1.7	2.8	4.3	1.7	5.0	5.5	ns
t_{en}	enable time	$\overline{OE}$ to Y; see Fig. 9	[3]							
		V_{CC} = 0.8 V		-	74.0	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		3.6	7.4	16.3	3.2	18.2	20.1	ns
		V_{CC} = 1.4 V to 1.6 V		2.3	5.1	9.2	2.1	10.9	12.0	ns
		V_{CC} = 1.65 V to 1.95 V		2.0	4.1	7.1	1.8	8.5	9.4	ns
		V_{CC} = 2.3 V to 2.7 V		1.8	3.4	5.4	1.7	6.4	7.1	ns
		V_{CC} = 3.0 V to 3.6 V		1.8	3.1	4.8	1.7	5.7	6.3	ns

Symbol	Parameter	Conditions		25 °C			-40 °C to +125 °C			Unit
				Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
t_{dis}	disable time	$\overline{OE}$ to Y; see Fig. 9	[4]							
		V_{CC} = 0.8 V		-	33.7	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		3.4	5.4	9.0	3.2	10.0	11.0	ns
		V_{CC} = 1.4 V to 1.6 V		2.1	4.1	6.3	2.1	7.1	7.9	ns
		V_{CC} = 1.65 V to 1.95 V		2.3	4.2	6.3	1.8	7.1	7.9	ns
		V_{CC} = 2.3 V to 2.7 V		1.6	3.0	4.6	1.7	5.2	5.7	ns
		V_{CC} = 3.0 V to 3.6 V		2.1	3.8	5.7	1.7	6.4	7.1	ns
C_L = 15 pF										
t_{pd}	propagation delay	A to Y; see Fig. 8	[2]							
		V_{CC} = 0.8 V		-	29.0	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		3.9	7.4	16.3	3.6	18.4	20.2	ns
		V_{CC} = 1.4 V to 1.6 V		3.0	5.1	9.4	2.5	11.1	12.3	ns
		V_{CC} = 1.65 V to 1.95 V		2.2	4.2	7.2	2.1	8.7	9.6	ns
		V_{CC} = 2.3 V to 2.7 V		2.0	3.5	5.4	1.9	6.5	7.2	ns
		V_{CC} = 3.0 V to 3.6 V		2.0	3.3	4.9	1.9	5.7	6.4	ns
t_{en}	enable time	$\overline{OE}$ to Y; see Fig. 9	[3]							
		V_{CC} = 0.8 V		-	77.8	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		4.0	8.2	18.2	3.6	20.4	22.5	ns
		V_{CC} = 1.4 V to 1.6 V		3.0	5.6	10.3	2.5	12.2	13.4	ns
		V_{CC} = 1.65 V to 1.95 V		2.3	4.6	7.9	2.1	9.5	10.5	ns
		V_{CC} = 2.3 V to 2.7 V		2.1	3.9	6.0	2.0	7.2	7.9	ns
		V_{CC} = 3.0 V to 3.6 V		2.1	3.6	5.5	1.9	6.4	7.1	ns
t_{dis}	disable time	$\overline{OE}$ to Y; see Fig. 9	[4]							
		V_{CC} = 0.8 V		-	62.5	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		4.3	6.6	10.4	3.6	11.6	12.8	ns
		V_{CC} = 1.4 V to 1.6 V		3.0	5.0	7.4	2.5	8.4	9.3	ns
		V_{CC} = 1.65 V to 1.95 V		3.0	5.3	7.8	2.1	8.7	9.7	ns
		V_{CC} = 2.3 V to 2.7 V		2.1	3.8	5.7	2.0	6.4	7.1	ns
		V_{CC} = 3.0 V to 3.6 V		2.9	5.0	7.4	1.9	8.3	9.1	ns
C_L = 30 pF										
t_{pd}	propagation delay	A to Y; see Fig. 8	[2]							
		V_{CC} = 0.8 V		-	39.1	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		5.0	9.7	21.6	4.6	24.3	26.8	ns
		V_{CC} = 1.4 V to 1.6 V		4.0	6.7	12.3	3.0	14.6	16.1	ns
		V_{CC} = 1.65 V to 1.95 V		2.9	5.5	9.5	2.7	11.5	12.6	ns
		V_{CC} = 2.3 V to 2.7 V		2.7	4.6	7.1	2.5	8.6	9.5	ns
		V_{CC} = 3.0 V to 3.6 V		2.6	4.3	6.4	2.5	7.7	8.5	ns

Symbol	Parameter	Conditions	25 °C			-40 °C to +125 °C			Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
t_{en}	enable time	$\overline{OE}$ to Y; see Fig. 9 [3]							
		V_{CC} = 0.8 V	-	89.4	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	5.2	10.6	23.8	4.6	26.7	29.5	ns
		V_{CC} = 1.4 V to 1.6 V	4.0	7.3	13.2	3.0	15.7	17.4	ns
		V_{CC} = 1.65 V to 1.95 V	3.0	6.0	10.2	2.7	12.3	13.6	ns
		V_{CC} = 2.3 V to 2.7 V	2.8	5.0	7.8	2.6	9.3	10.3	ns
		V_{CC} = 3.0 V to 3.6 V	2.8	4.8	7.1	2.6	8.4	9.3	ns
t_{dis}	disable time	$\overline{OE}$ to Y; see Fig. 9 [4]							
		V_{CC} = 0.8 V	-	68.9	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	6.0	9.3	15.0	4.6	16.5	18.2	ns
		V_{CC} = 1.4 V to 1.6 V	4.4	7.7	11.0	3.0	12.2	13.4	ns
		V_{CC} = 1.65 V to 1.95 V	5.1	8.8	12.4	2.7	13.7	15.1	ns
		V_{CC} = 2.3 V to 2.7 V	3.6	6.2	9.0	2.6	10.0	11.0	ns
		V_{CC} = 3.0 V to 3.6 V	5.2	8.8	12.7	2.6	14.0	15.4	ns
C_L = 5 pF, 10 pF, 15 pF and 30 pF									
C_{PD}	power dissipation capacitance	f_i = 1 MHz; V_I = GND to V_{CC} [5]							
		V_{CC} = 0.8 V	-	2.7	-	-	-	-	pF
		V_{CC} = 1.1 V to 1.3 V	-	2.9	-	-	-	-	pF
		V_{CC} = 1.4 V to 1.6 V	-	3.0	-	-	-	-	pF
		V_{CC} = 1.65 V to 1.95 V	-	3.2	-	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V	-	3.7	-	-	-	-	pF
		V_{CC} = 3.0 V to 3.6 V	-	4.2	-	-	-	-	pF

[1] All typical values are measured at nominal V_{CC}.
[2] t_{pd} is the same as t_{PLH} and t_{PHL}
[3] t_{en} is the same as t_{PZH} and t_{PZL}
[4] t_{dis} is the same as t_{PHZ} and t_{PLZ}
[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

11.1. Waveforms and test circuit



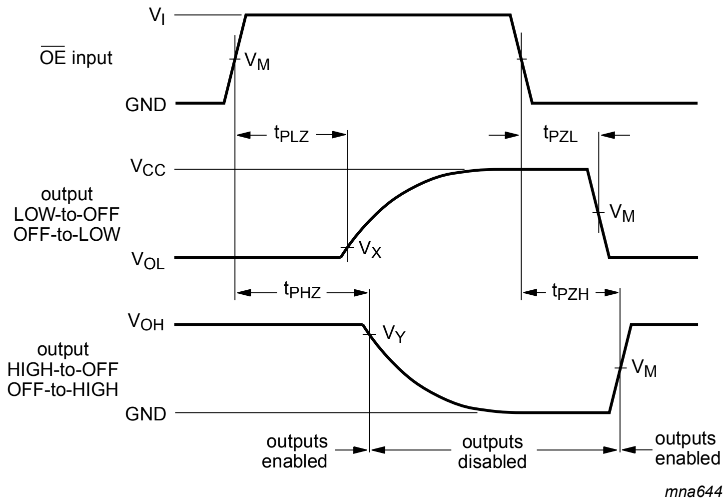
Measurement points are given in Table 9.

Logic levels: V_{OL} and V_{OH} are typical output voltage drop that occur with the output load.

Fig. 8. The data input (A) to output (Y) propagation delays

Table 9. Measurement points

Supply voltage	Output	Input		
V_{CC}	V_M	V_M	V_I	$t_r = t_f$
0.8 V to 3.6 V	0.5 × V_{CC}	0.5 × V_{CC}	V_{CC}	≤ 3.0 ns



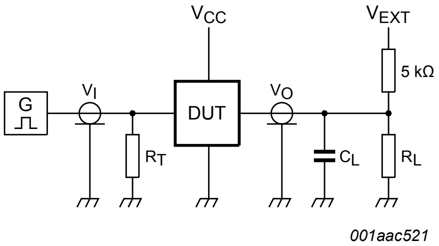
Measurement points are given in Table 10.

Logic levels: V_{OL} and V_{OH} are typical output voltage drop that occur with the output load.

Fig. 9. Enable and disable time

Table 10. Measurement points

Supply voltage	Input	Output		
V_{CC}	V_M	V_M	V_X	V_Y
0.8 V to 1.6 V	0.5 x V_{CC}	0.5 x V_{CC}	V_{OL} + 0.1 V	V_{OH} - 0.1 V
1.65 V to 2.7 V	0.5 x V_{CC}	0.5 x V_{CC}	V_{OL} + 0.15 V	V_{OH} - 0.15 V
3.0 V to 3.6 V	0.5 x V_{CC}	0.5 x V_{CC}	V_{OL} + 0.3 V	V_{OH} - 0.3 V



Test data is given in Table 11.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig. 10. Test circuit for measuring switching times

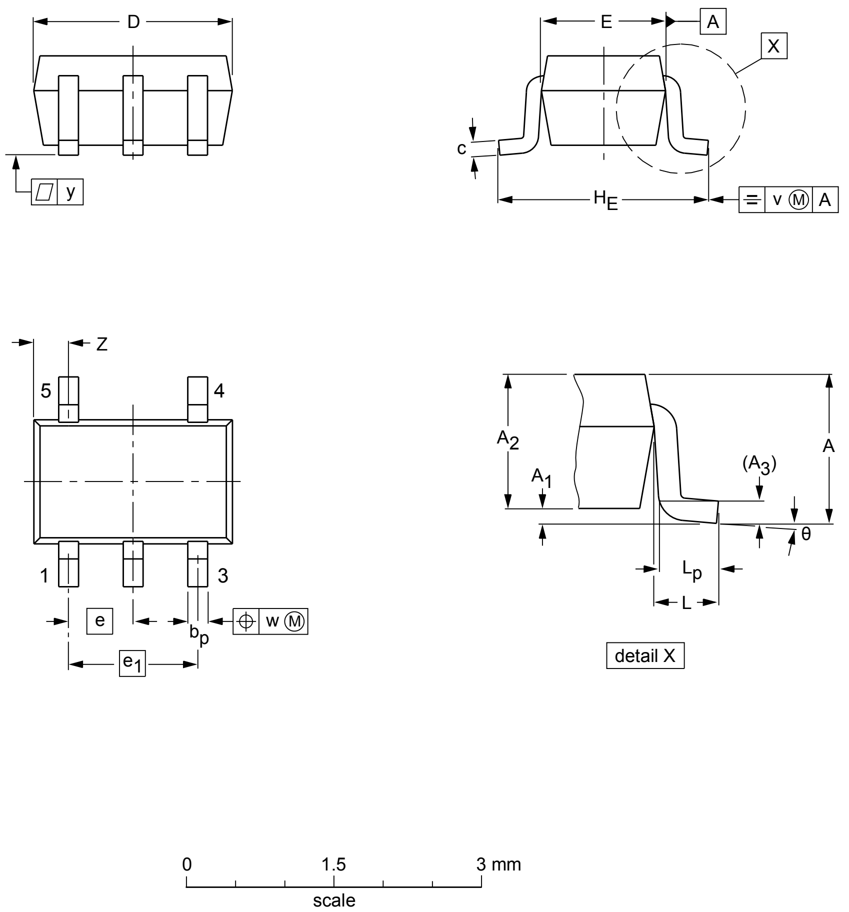
Table 11. Test data

Supply voltage	Load		V_{EXT}		
V_{CC}	C_L	R_L [1]	t_{PLH}, t_{PHL}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	2 x V_{CC}

[1] For measuring enable and disable times R_L = 5 kΩ.
For measuring propagation delays, setup and hold times and pulse width R_L = 1 MΩ.

12. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm **SOT353-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	D(1)	E(1)	e	e_1	H_E	L	L_p	v	w	y	Z(1)	θ
mm	1.1	0.1 0	1.0 0.8	0.15	0.30 0.15	0.25 0.08	2.25 1.85	1.35 1.15	0.65	1.3	2.25 2.0	0.425	0.46 0.21	0.3	0.1	0.1	0.60 0.15	7° 0°

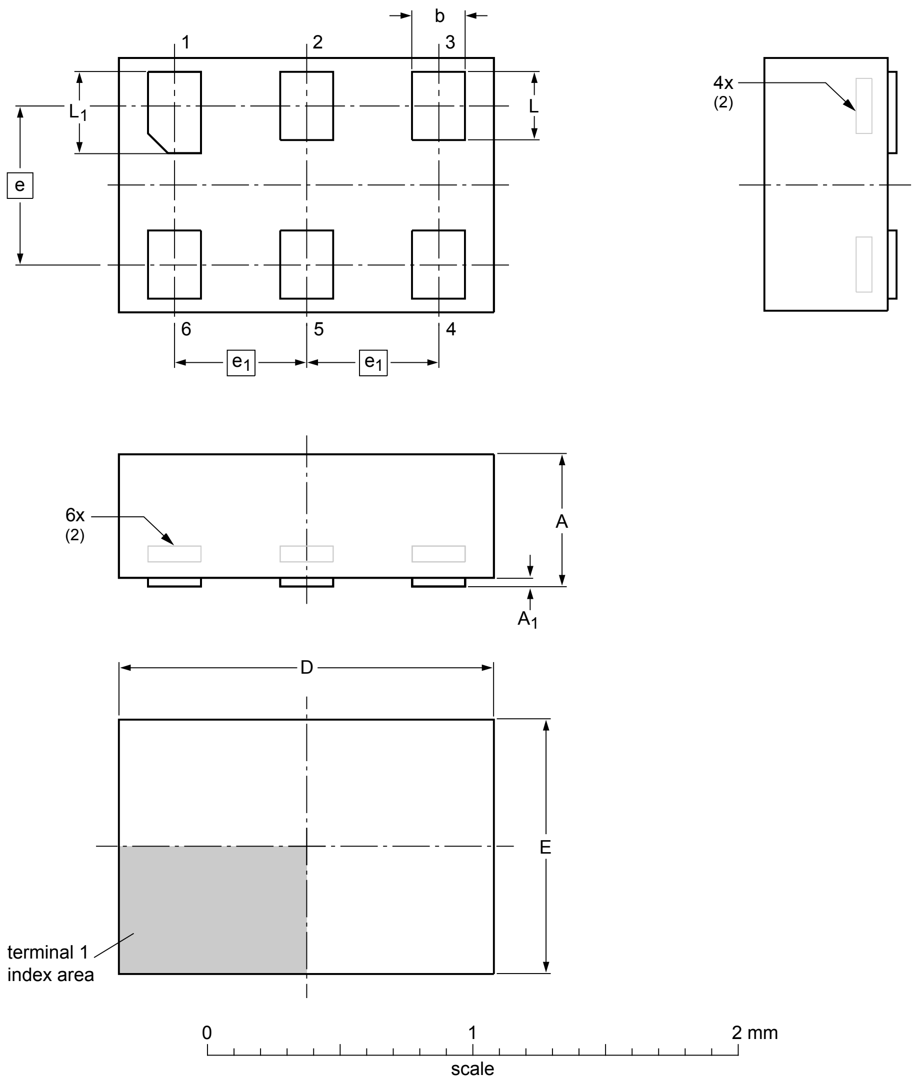
Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT353-1		MO-203	SC-88A			~~00-09-01~~ 03-02-19

Fig. 11. Package outline SOT353-1 (TSSOP5)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1.45 x 0.5 mm SOT886



Dimensions (mm are the original dimensions)

Unit		A(1)	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.5	0.04	0.25	1.50	1.05			0.35	0.40
	nom			0.20	1.45	1.00	0.6	0.5	0.30	0.35
	min			0.17	1.40	0.95			0.27	0.32

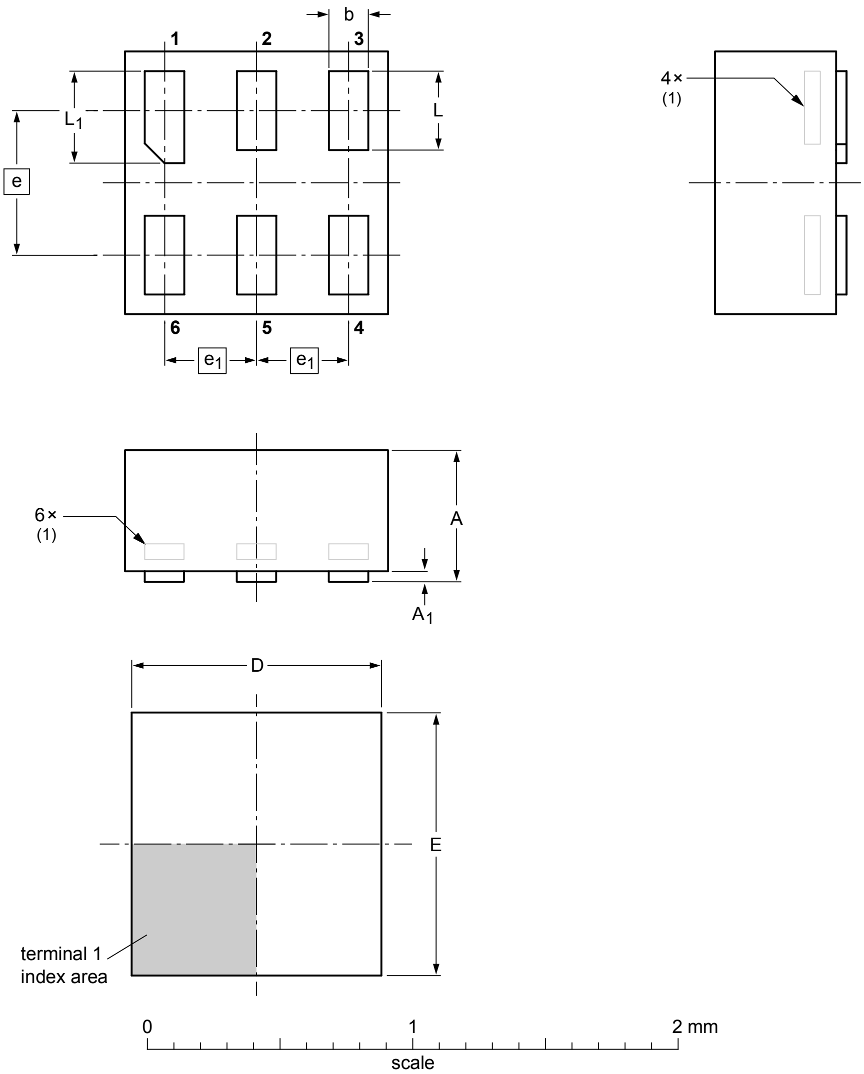
Notes
1. Including plating thickness.
2. Can be visible in some manufacturing processes.

sot886_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT886		MO-252				~~04-07-22~~ 12-01-05

Fig. 12. Package outline SOT886 (XSON6)

XSON6: plastic extremely thin small outline package; no leads; 6 terminals; body 1 x 1 x 0.5 mm **SOT891**



DIMENSIONS (mm are the original dimensions)

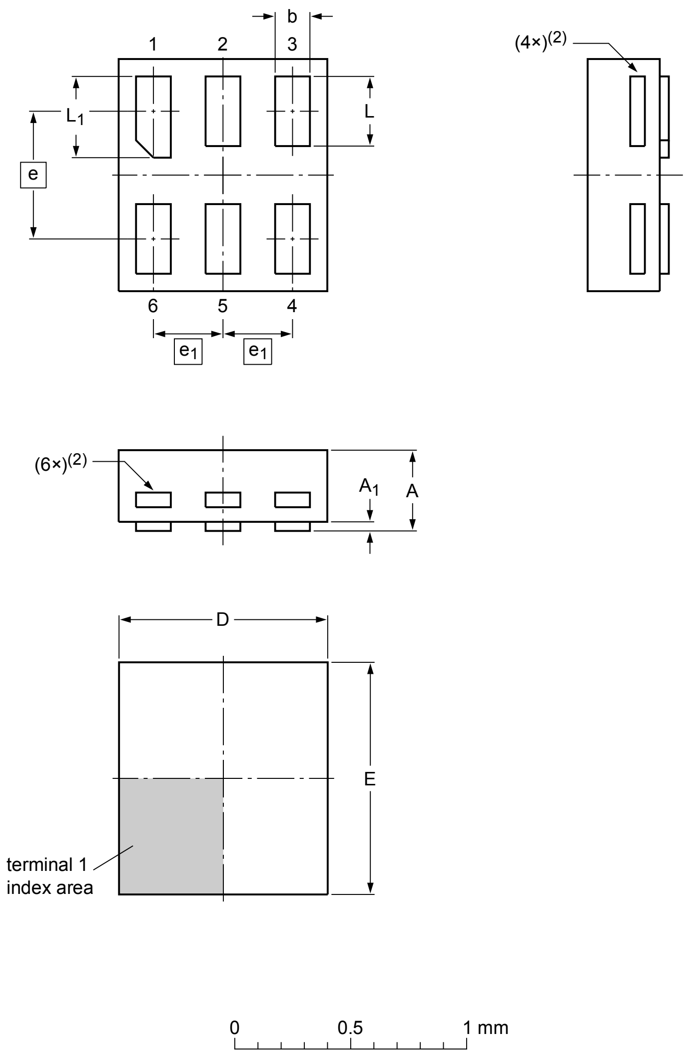
UNIT	A max	A_1 max	b	D	E	e	e_1	L	L_1
mm	0.5	0.04	0.20 0.12	1.05 0.95	1.05 0.95	0.55	0.35	0.35 0.27	0.40 0.32

Note
1. Can be visible in some manufacturing processes.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT891						~~05-04-06~~ 07-05-15

Fig. 13. Package outline SOT891 (XSON6)

XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm **SOT1115**



Dimensions

Unit		A(1)	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.35	0.04	0.20	0.95	1.05			0.35	0.40
	nom			0.15	0.90	1.00	0.55	0.3	0.30	0.35
	min			0.12	0.85	0.95			0.27	0.32

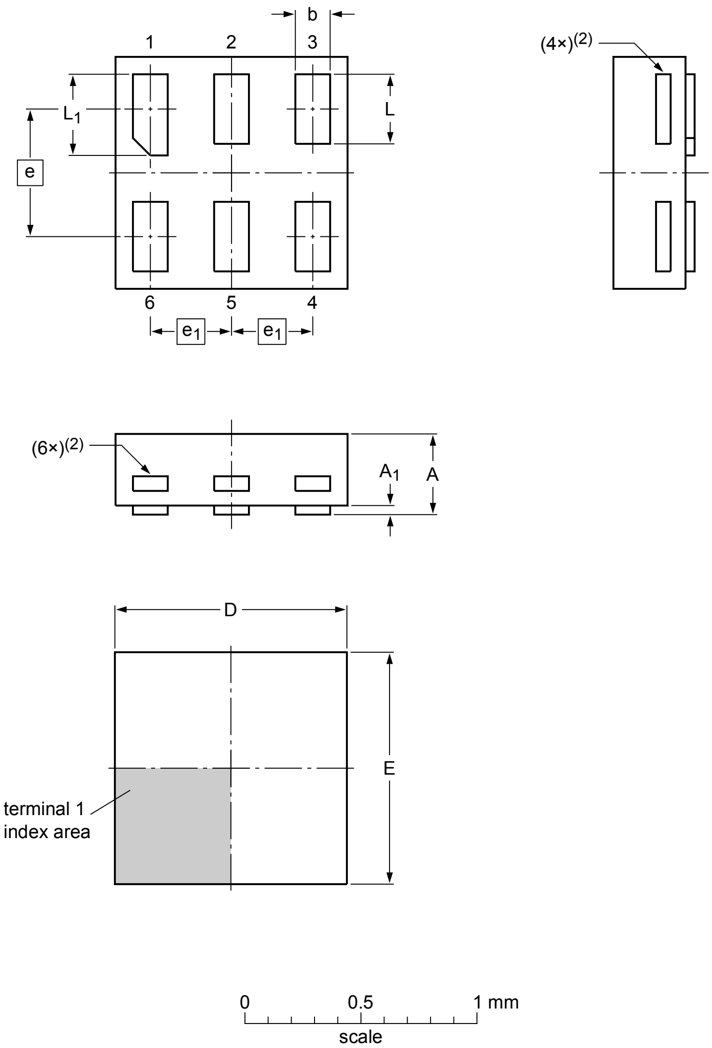
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1115_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1115						~~10-04-02~~ 10-04-07

Fig. 14. Package outline SOT1115 (XSON6)

XSON6: extremely thin small outline package; no leads;
6 terminals; body 1.0 x 1.0 x 0.35 mm **SOT1202**



Dimensions

Unit		A(1)	A_1	b	D	E	e	e_1	L	L_1
	max	0.35	0.04	0.20	1.05	1.05			0.35	0.40
mm	nom			0.15	1.00	1.00	0.55	0.35	0.30	0.35
	min			0.12	0.95	0.95			0.27	0.32

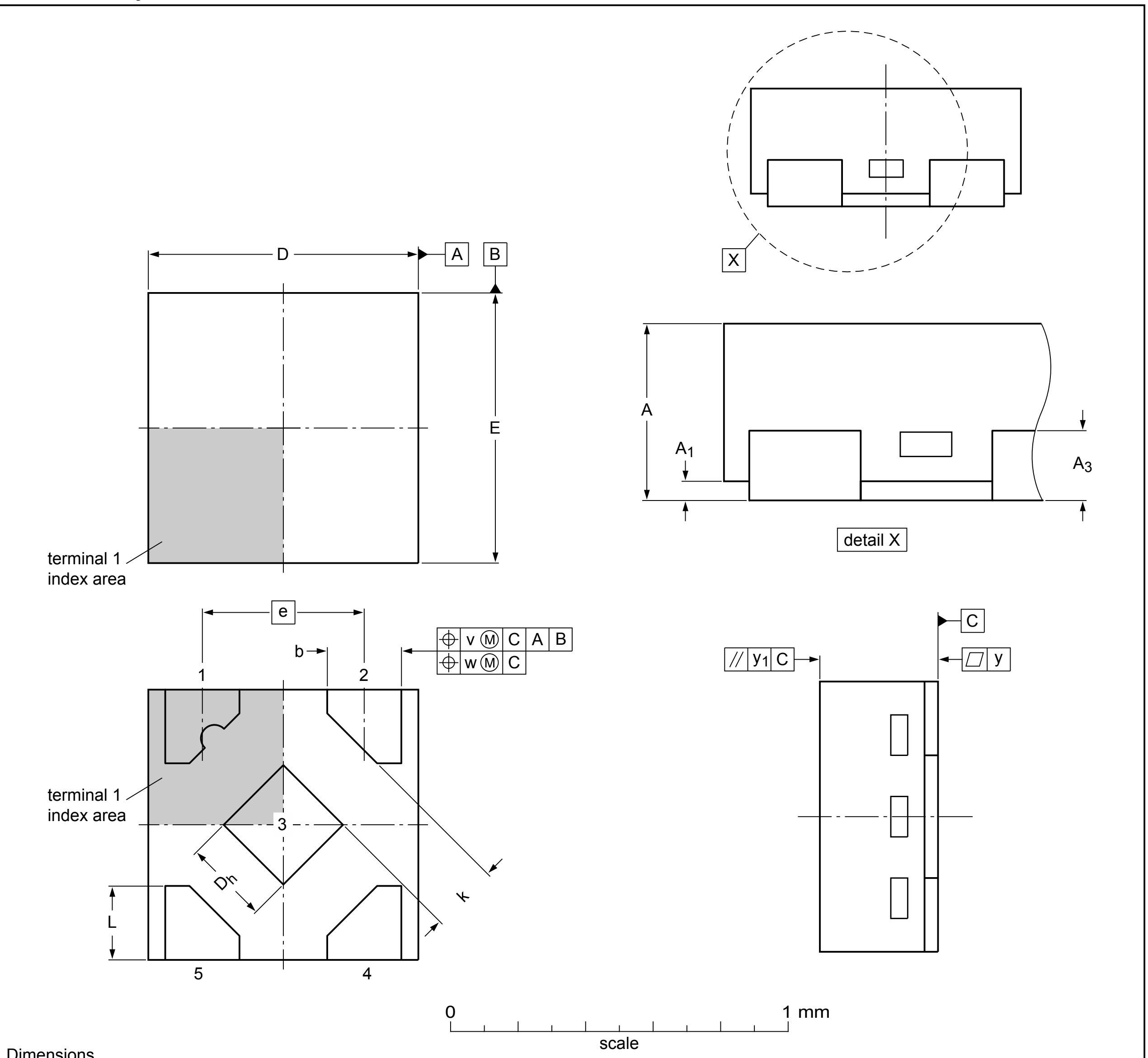
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1202_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1202						~~10-04-02~~ 10-04-06

Fig. 15. Package outline SOT1202 (XSON6)

X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body 0.8 x 0.8 x 0.35 mm **SOT1226**



Dimensions

Unit		A(1)	A_1	A_3	D	D_h	E	b	e	k	L	v	w	y	y_1
mm	max	0.35	0.04	0.128	0.85	0.30	0.85	0.27			0.27				
	nom				0.80	0.25	0.80	0.22	0.48		0.22	0.1	0.05	0.05	0.05
	min			0.040	0.75	0.20	0.75	0.17		0.20	0.17				

Note
1. Dimension A is including plating thickness.
2. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

sot1226_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	EIAJ			
SOT1226						~~12-04-10~~ 12-04-25

Fig. 16. Package outline SOT1226 (X2SON5)

13. Abbreviations

Table 12. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

14. Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP1G240 v.5	20190315	Product data sheet	-	74AUP1G240 v.4
Modifications:	• The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. • Legal texts have been adapted to the new company name where appropriate.			
74AUP1G240 v.4	20120629	Product data sheet	-	74AUP1G240 v.3
Modifications:	• Added type number 74AUP1G240GX (SOT1226) • Package outline drawing of SOT886 (Fig. 12) modified.			
74AUP1G240 v.3	20111124	Product data sheet	-	74AUP1G240 v.2
Modifications:	• Legal pages updated.			
74AUP1G240 v.2	20100913	Product data sheet	-	74AUP1G240 v.1
74AUP1G240 v.1	20061106	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at https://www.nexperia.com.

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ООО «ЛайфЭлектроникс» "LifeElectronics" LLC

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- *Конкурентоспособные цены и скидки постоянным клиентам.*
- *Специальные условия для постоянных клиентов.*
- *Подбор аналогов.*
- *Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.*

- *Приемлемые сроки поставки, возможна ускоренная поставка.*
- *Доставку товара в любую точку России и стран СНГ.*
- *Комплексную поставку.*
- *Работу по проектам и поставку образцов.*
- *Формирование склада под заказчика.*

- *Сертификаты соответствия на поставляемую продукцию (по желанию клиента).*
- *Тестирование поставляемой продукции.*
- *Поставку компонентов, требующих военную и космическую приемку.*
- *Входной контроль качества.*
- *Наличие сертификата ISO.*

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- *Регистрацию проекта у производителя компонентов.*
- *Техническую поддержку проекта.*
- *Защиту от снятия компонента с производства.*
- *Оценку стоимости проекта по компонентам.*
- *Изготовление тестовой платы монтаж и пусконаладочные работы.*

Тел: +7 (812) 336 43 04 (многоканальный)
Email: org@lifeelectronics.ru

www.lifeelectronics.ru